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## ISO/IEC JTC1/SC17 STANDING DOCUMENT 5

### Register of IC manufacturers

Identifier	Company	Country
'01'	Motorola	UK
'02'	STMicroelectronics SA	France
'03'	Hitachi, Ltd	Japan
'04'	NXP Semiconductors	Germany
'05'	Infineon Technologies AG	Germany
'06'	Cylink	USA
'07'	Texas Instrument	France
'08'	Fujitsu Limited	Japan
'09'	Matsushita Electronics Corporation, Semiconductor Company	Japan
'0A'	NEC	Japan
'0B'	Oki Electric Industry Co. Ltd	Japan
'0C'	Toshiba Corp.	Japan
'0D'	Mitsubishi Electric Corp.	Japan
'0E'	Samsung Electronics Co. Ltd	Korea
'0F'	Hynix	Korea
'10'	LG-Semiconductors Co. Ltd	Korea
'11'	Emosyn-EM Microelectronics	USA
'12'	INSIDE Technology	France
'13'	ORGA Kartensysteme GmbH	Germany
'14'	SHARP Corporation	Japan
'15'	ATMEL	France
'16'	EM Microelectronic-Marin SA	Switzerland
'17'	KSW Microtec GmbH	Germany
'18'	ZMD AG	Germany
'19'	XICOR, Inc.	USA
'1A'	Sony Corporation	Japan

<b>Identifier</b>	<b>Company</b>	<b>Country</b>
'1B'	Malaysia Microelectronic Solutions Sdn. Bhd	Malaysia
'1C'	Emosyn	USA
'1D'	Shanghai Fudan Microelectronics Co. Ltd.	P.R. China
'1E'	Magellan Technology Pty Limited	Australia
'1F'	Melexis NV BO	Switzerland
'20'	Renesas Technology Corp.	Japan
'21'	TAGSYS	France
'22'	Transcore	USA
'23'	Shanghai belling corp., ltd.	China
'24'	Masktech Germany Gmbh	Germany
'25'	Innovision Research and Technology Plc	UK
'26'	Hitachi ULSI Systems Co., Ltd.	Japan
'27'	Cypak AB	Sweden
'28'	Ricoh	Japan
'29'	ASK	France
'2A'	Unicore Microsystems, LLC	Russian Federation
'2B'	Dallas Semiconductor/Maxim	USA
'2C'	Impinj, Inc.	USA
'2D'	RightPlug Alliance	USA
'2E'	Broadcom Corporation	USA
'2F'	MStar Semiconductor, Inc	Taiwan, ROC
'30'	BeeDar Technology Inc.	USA
'31'	RFIDsec	Denmark
'32'	Schweizer Electronic AG	Germany
'33'	AMIC Technology Corp	Taiwan
'34'	Mikron JSC	Russia
'35'	Fraunhofer Institute for Photonic Microsystems	Germany
'36'	IDS Microchip AG	Switzerland
'37'	Kovio	USA
'38'	HMT Microelectronic Ltd	Switzerland

<b>Identifier</b>	<b>Company</b>	<b>Country</b>
'39'	Silicon Craft Technology	Thailand
'3A'	Advanced Film Device Inc.	Japan
'3B'	Nitecrest Ltd	UK
'3C'	Verayo Inc.	USA
'3D'	HID Global	USA
'3E'	Productivity Engineering Gmbh	Germany
'3F'	Austriamicrosystems AG (reserved)	Austria
'40'	Gemalto SA	France
'41'	Renesas Electronics Corporation	Japan
'42'	3Alogics Inc	Korea
'43'	Top TroniQ Asia Limited	Hong Kong
'44'	Gentag Inc (USA)	USA